TFT
SPECIFICATION

Part Number	USMP-T022-024032NCJ-A0
Size	2.2"
Resolution	240 x 320
Brightness	400 cd/m²
Contrast	700:1
Viewing Angle	80/80/80/80
Operating Temp.	-20 ~ 70°C

FOR ADDITIONAL INFORMATION
PLEASE CONTACT:
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Issue Date	Approved by (customer use)	Checked by	Prepared by

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RECORD OF REVISION

Revision Date	Page	Contents	Editor
2013/11/22	-	New Release	Patrick
2014/6/18	1,5,7	Modify Features, Electrical specifications, Optical characteristics.	Alan
2014/07/07	6,7	Mention the LED life time.	Emil

1 Features

This single-display module is suitable for cellphone application. The Main-LCD adopts one backlight with High brightness 3-lamps white LED.

(1) Main LCD : 1.1 MVA-TFT 2.2 inch display, transmissive, Normally Black

     1.2 240(RGB) X 320 dots Matrix

     1.3 Narrow-contact ledge technique.

     1.4 Main LCD Driver IC: ST7789S-G4

     1.5 Real 262K colors display:

      65K: Red-5bit, Green-6bit, Blue-5bit (8/16-bit interface)

      262K: Red-6bit, Green-6bit, Blue-6bit (9/18-bit interface)

(2) Direct data display with display RAM

(3) MPU interface: 8bit/16bit/18bit, 80Serial, parallel interface.

(4) RGB interface:16bit/18bit parallel interface

2 Mechanical specifications

Dimensions and weight

Item		Specifications	Unit
External shape dimensions		40.1 (W) x 71.9 (H) x 3.65 (D) Max.	mm
Main LCD	Pixel pitch	0.1395 (W) x 0.1395(H)	mm
	Active area	33.48 (W) x 44.64 (H)	mm
	Viewing area	35.08 (W) x 46.24 (H)	mm

*1. This specification is about External shape on shipment.

3 Absolute max. ratings and environment

3-1 Absolute max. ratings

$Ta=25^oC$　　GND=0V

Item	Symbol	Min.	Max.	Unit	Remarks
Power voltage	VDD – GND	-0.3	+4.0	V	
Power voltage	LED A – LED K	-0.5	+10.8	V	
Input voltage	VIN	-0.5	VDDI+0.5	V	

3-2 Environment

Item	Specifications	Remarks
Storage temperature	Max. +80 ^oC Min. -30 ^oC	Note 1: Non-condensing
Operating temperature	Max. +70 ^oC Min. -20 ^oC	Note 1: Non-condensing

Note 1：$Ta \leqq +40^oC$ ・・・・ Max.85%RH

$Ta > +40^oC$ ・・・・ The max. humidity should not exceed the humidity

with 40 ^oC 85%RH.

4 Electrical specifications

4-1 Electrical characteristics of LCM

$(V_{DD}=2.8V, Ta=25\,^{o}C)$

Item	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	Note
IC power voltage	V_{DD}		2.4	2.75	3.3	V	
High-level input voltage	V_{IHC}		$0.8V_{DD}$		V_{DD}	V	Note 1,2,3
Low-level input voltage	V_{ILC}		0		$0.2V_{DD}$	V	
Consumption current of VDD	I_{DD}	LED OFF	-	7	14	mA	
Consumption current of LED	I_{LED}	$V_{LED}=8.7V$	-	15	20	mA	

※ 1. 1/320 duty.

2. Electronic Volumn value: (xxxxh) Decimal

3. Thermal Gradient: -0.05%/^{o}C

4. Range of Electronic Volumn control : (xxxxH+3) Decimal

4-2 LED back light specification

Item	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	V_f	I_f =15mA	7.8	8.7	9.9	V
Reverse voltage	V_r		-	-	12	V
Forward current	I_f	3-chip serial	12	15	20	mA
Power Consumption	P_{BL}	I_f =15mA	-	130	-	mW
Uniformity (with L/G)	-	I_f=15mA	70%*1	-	-	
Luminous color	White					
Chip connection	3 chip serial connection					
LED life time *2	20000Hours					

Bare LED measure position:
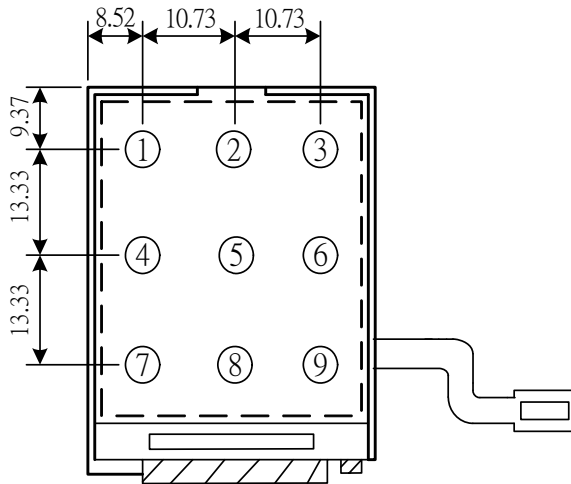
*1 Uniformity (LT): $\dfrac{Min(P1 \sim P9)}{Max(P1 \sim P9)} \times 100$

*2 : Condition: Ta=25℃, continuous lighting

Life time is estimated data.

Definitions of failure:

1. LCM brightness becomes half of the minimum value.

2. LED doesn't light normally.

5 Optical characteristics

Main LCD

5.1 Optical characteristics

(1/320 Duty in case except as specified elsewhere Ta = 25°C)

LED backlight transmissive module:

Item	Symbol	Temp.	Min.	Std.	Max.	Unit	Conditions
Response time	Tr+Tf		-	55	85	ms	$\theta=0^{o}$, $\varphi=0^{o}$ (Note 2)
Contrast ratio	CR	25 °C	300	700	-	-	$\theta=0^{o}$, $\varphi=0^{o}$ LED:ON, LIGHT:OFF (Note 4)
Visual angle range front and rear	θ	25 °C				Degree	$\varphi=0^{o}$, $CR\geqq10$ LED:ON LIGHT:OFF (Note 3)
Visual angle range left and right	θ	25 °C				Degree	$\varphi=90^{o}$, $CR\geqq10$ LED:ON LIGHT:OFF (Note 3)
Brightness			300	400		Cd/m2	$V_{LED}=8.7V$, 15mA Full White pattern
LED life time	-	25 °C	20			kHrs	$V_{LED}=8.7V$, 15mA

For the Visual angle range front and rear: (θf) 80, (θb) 80

For the Visual angle range left and right: (θl) 80, (θr) 80

*1 This value is reference only, follow the limited samples.

*2 : Condition: Ta=25℃, continuous lighting
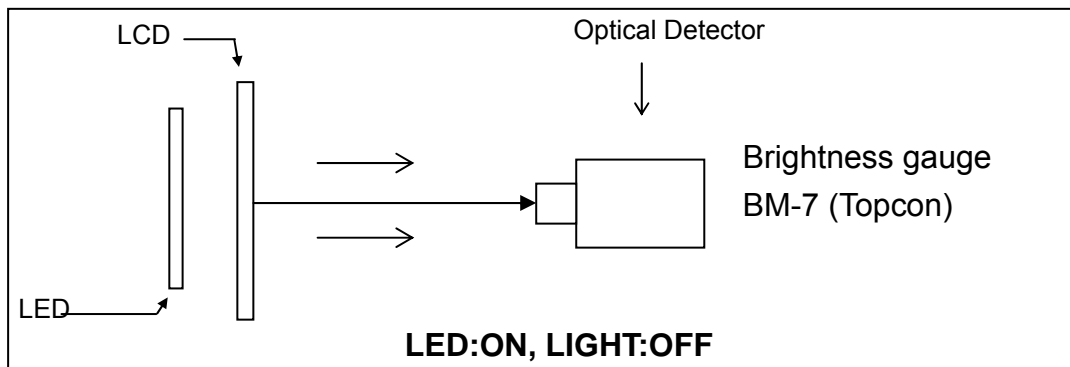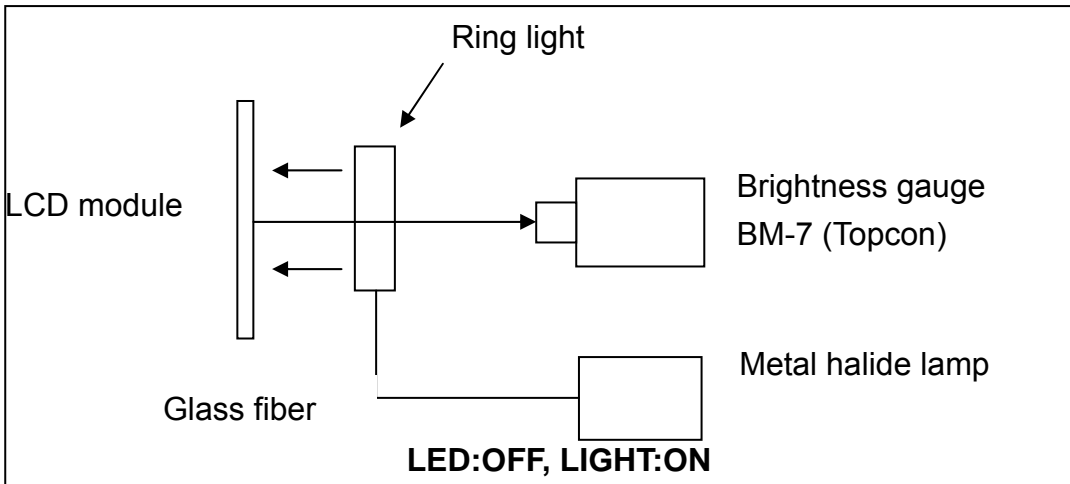
Life time is estimated data.

Definitions of failure:

1. LCM brightness becomes half of the minimum value.

2. LED doesn't light normally.
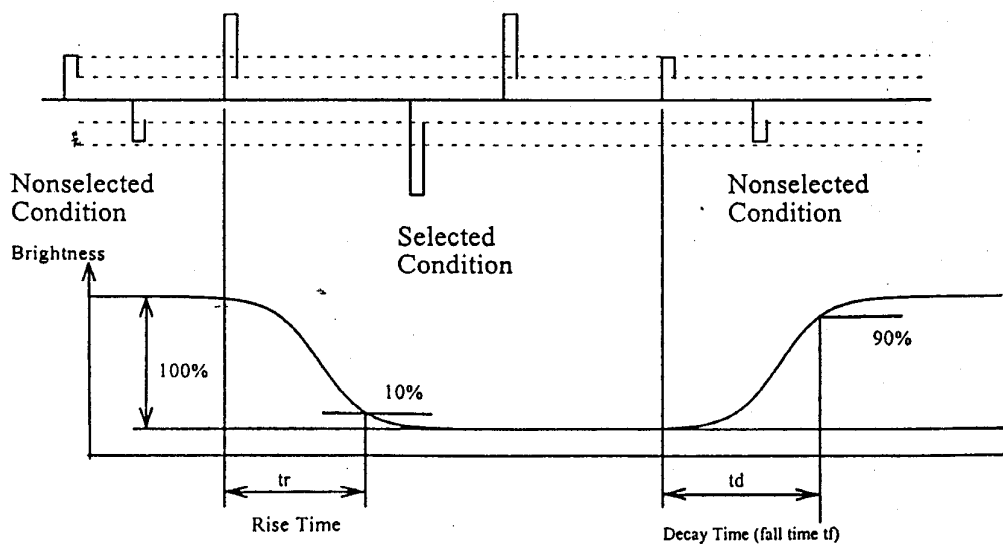
5.2 CIE (x, y) chromaticity (1/320 Duty Ta = 25°C)

Item	Symbol	Tranmissive			Conditions
		R G B W Range			
		Min	Typ	Max	
Red	XR	0.59	0.64	0.69	θ=0° ,φ=0°
	YR	0.29	0.34	0.39	
Green	XG	0.28	0.33	0.38	θ=0° ,φ=0°
	YG	0.53	0.58	0.63	
Blue	XB	0.1	0.15	0.2	θ=0° ,φ=0°
	YB	0.01	0.06	0.11	
White	XW	0.27	0.32	0.37	θ=0° ,φ=0°
	YW	0.30	0.35	0.40	

※ **The R G B W ranges are for reference**

NOTE 1: Optical characteristic measurement system

LCD module — Ring light — Brightness gauge BM-7 (Topcon) — Metal halide lamp — Glass fiber

LED:OFF, LIGHT:ON

LCD — Optical Detector — Brightness gauge BM-7 (Topcon) — LED

LED:ON, LIGHT:OFF

NOTE 2: Response time definition

Nonselected Condition

Selected Condition

Nonselected Condition

Brightness

100%

10%

90%

tr
Rise Time

td
Decay Time (fall time tf)

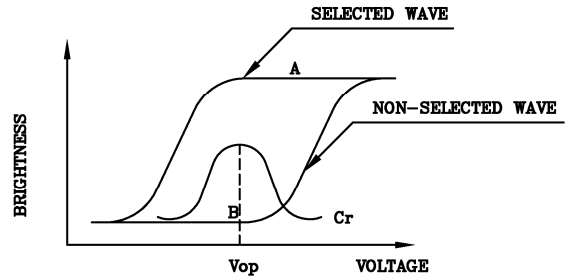## NOTE 3: φ 、 θ definition
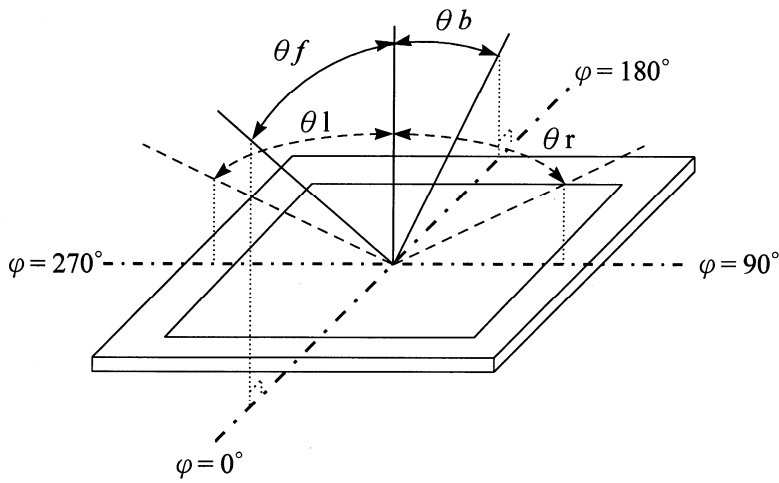
NOTE 4: Contrast definition
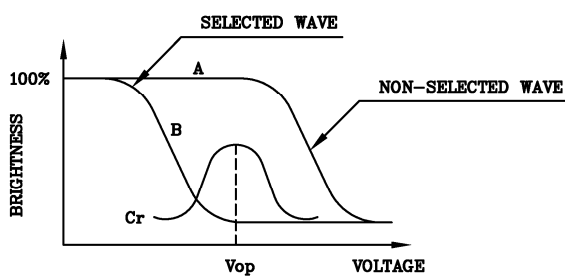
(positive type)   (negative type)

Contrast Ratio : Cr=A/B

NOTE 5: Visual angle direction priority

12 : 00

9 : 00   8 8 8 8   3 : 00

6 : 00
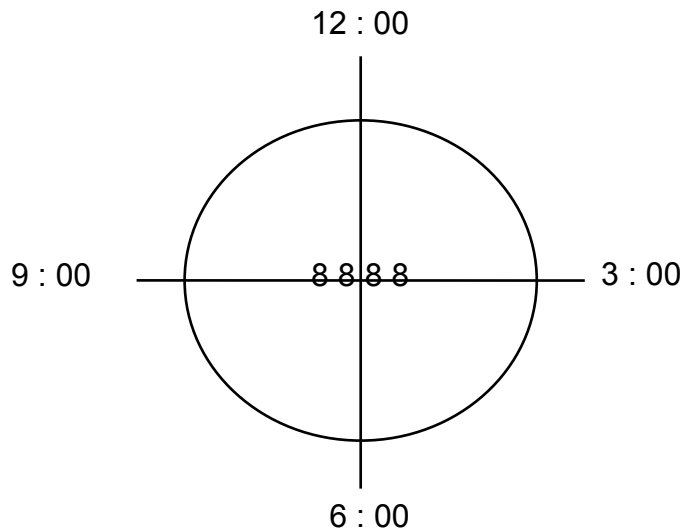
6 Block Diagram
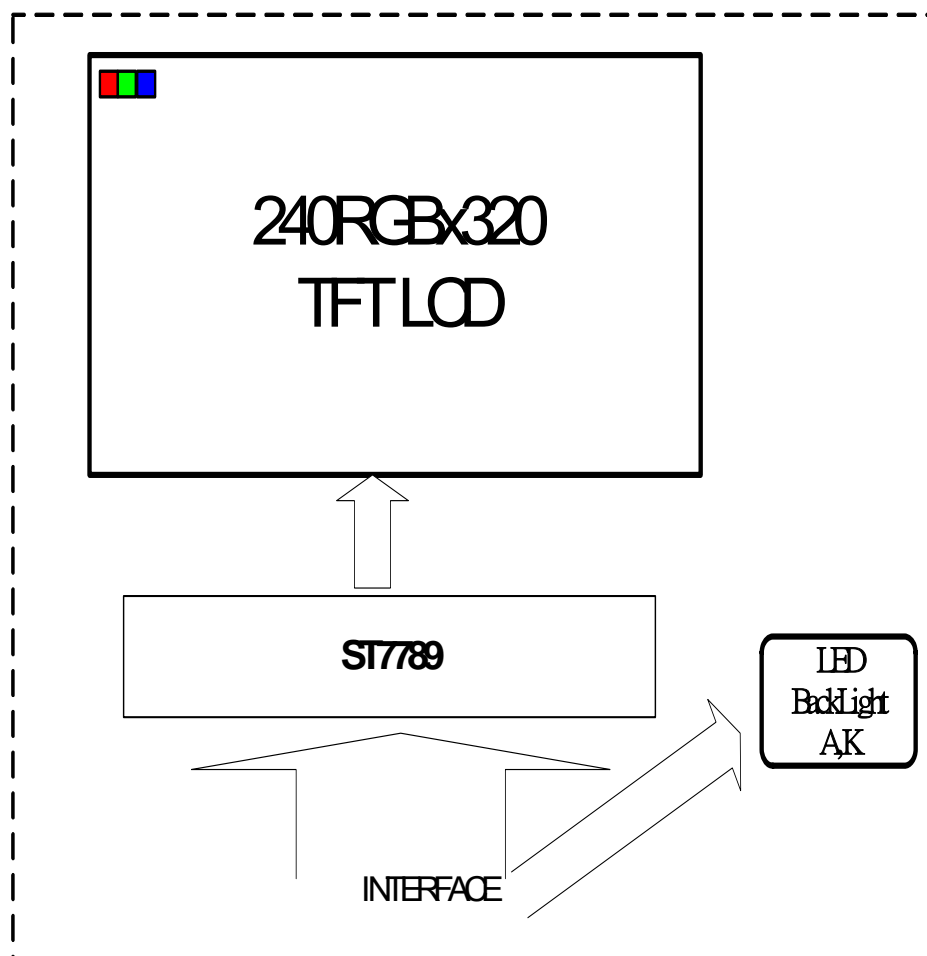
Block diagram (Main LCD)

Display format: MVA- TFT transmissive, Normally black type
Display composition: 240 RGB x 320 dots
LCD Driver :   ST7789S-G4
Back light: White LED x 3 (I_{LED}=15mA)

7 Interface specifications

Pin No.	Terminal	Functions
1	GND	Ground
2	GND	Ground
3	CSX	-Chip selection pin Low enable. High disable.
4	DCX	-Display data/command selection pin in parallel interface. -This pin is used to be serial interface clock. DCX='1': display data or parameter. DCX='0': command data. -If not used, please fix this pin at VDDI or DGND.
5	WRX	-Write enable in MCU parallel interface. - Display data/command selection pin in 4-line serial - Second Data lane in 2 data lane serial interface. -If not used, please fix this pin at VDDI or DGND.
6	RDX	-Read enable in 8080 MCU parallel interface. -If not used, please fix this pin at VDDI or DGND.
7	RESX	-This signal will reset the device and it must be applied to properly initialize the chip. -Signal is active low.
8	DB0	-DB[17:0] are used as MCU parallel interface data bus. 8-bit I/F: when IM3:0, DB[7:0] are used; when IM3:1, DB[17:10] are used. 9-bit I/F: when IM3:0, DB[8:0] are used; when IM3:1, DB[17:9] are used. 16-bit I/F: when IM3:0, DB[15:0] are used; when IM3:1, DB[17:10] and DB[8:1] are used. 18-bit I/F: DB[17:0] are used. -DB[17:0] are used as RGB interface data bus. 6-bit RGB I/F: DB[5:0] are used. 16-bit RGB I/F: DB[17:13], DB[11:1] are used. 18-bit RGB I/F: DB[17:0] are used. -If not used, please fix this pin at VDDI or DGND.
9	DB1	
10	DB2	
11	DB3	
12	DB4	
13	DB5	
14	DB6	
15	DB7	
16	DB8	
17	DB9	
18	DB10	
19	DB11	
20	DB12	
21	DB13	
22	DB14	
23	DB15	
24	LED A	Led Anode
25	LED K	Led Cathode
26	DB16	Data Bus
27	DB17	
28	IM3	Interface selecting signal. For the details,please refer to NOTE1.
29	IM2	Interface selecting signal. For the details,please refer to NOTE1.

30	IM1	Interface selecting signal. For the details,please refer to NOTE1.
31	IM0	Interface selecting signal. For the details,please refer to NOTE1.
32	SDA	Serial bus interface data input
33	SDO	SPI interface output pin.
34	VSYNC	Frame synchronizing signal in RGB I/F mode.
35	HSYNC	Horizontal (Line) synchronizing input signal for RGB interface
36	DOTCLK	Dot clock signal in RGB I/F mode.
37	NC(ENABLE)	No Connect
38	NC	No Connect
39	VDD	Power SupplyPower Supply for Analog, Digital System and Booster Circuit.
40	VDDI	Power Supply for I/O System.

Note 1:

IM3	IM2	IM1	IM0	MPU Interface Mode	Data pin
0	0	0	0	80-8bit parallel I/F	DB[7:0]
0	0	0	1	80-16bit parallel I/F	DB[15:0]
0	0	1	0	80-9bit parallel I/F	DB[8:0]
0	0	1	1	80-18bit parallel I/F	DB[17:0],
0	1	0	1	3-line 9bit serial I/F	SDA: in/out
0	1	0	1	2 data lane serial I/F	SDA: in/out WRX: in
0	1	1	0	4-line 8bit serial I/F	SDA: in/out
1	0	0	0	80-16bit parallel I/F Ⅱ	DB[17:10], DB[8:1]
1	0	0	1	80-8bit parallel I/F Ⅱ	DB[17:10]
1	0	1	0	80-18bit parallel I/F Ⅱ	DB[17:0],
1	0	1	1	80-9bit parallel I/F Ⅱ	DB[17:9]
1	1	0	1	3-line 9bit serial I/F Ⅱ	SDA: in/ SDO: out
1	1	1	0	4-line 8bit serial I/F Ⅱ	SDA:in/ SDO: out

8   Timing Characteristics

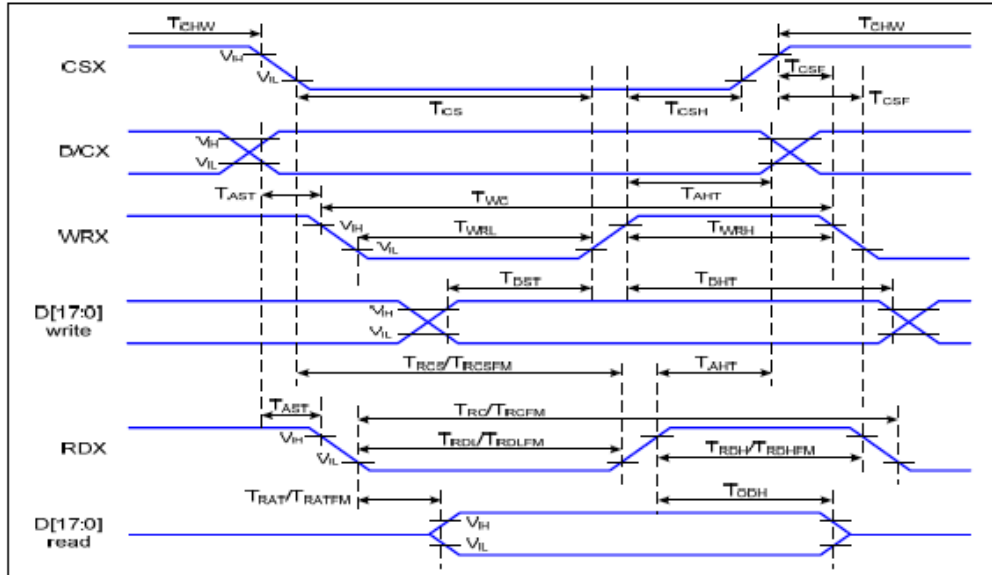8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus

Figure 1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)

$VDDI=1.65$ to $3.3V$, $VDD=2.4$ to $3.3V$, $AGND=DGND=0V$, $Ta= -30$ to 70 ℃

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T_{AST}	Address setup time	0		ns	-
	T_{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T_{CHW}	Chip select "H" pulse width	0		ns	-
	T_{CS}	Chip select setup time (Write)	15		ns	
	T_{RCS}	Chip select setup time (Read ID)	45		ns	
	T_{RCSFM}	Chip select setup time (Read FM)	355		ns	
	T_{CSF}	Chip select wait time (Write/Read)	10		ns	
	T_{CSH}	Chip select hold time	10		ns	
WRX	T_{WC}	Write cycle	66		ns	
	T_{WRH}	Control pulse "H" duration	15		ns	
	T_{WRL}	Control pulse "L" duration	15		ns	
RDX (ID)	T_{RC}	Read cycle (ID)	160		ns	When read ID data
	T_{RDH}	Control pulse "H" duration (ID)	90		ns	
	T_{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX (FM)	T_{RCFM}	Read cycle (FM)	450		ns	When read from frame memory
	T_{RDHFM}	Control pulse "H" duration (FM)	90		ns	
	T_{RDLFM}	Control pulse "L" duration (FM)	355		ns	
D[17:0]	T_{DST}	Data setup time	10		ns	For CL=30pF

T$_{DHT}$	Data hold time	10		ns	
T$_{RAT}$	Read access time (ID)		40	ns	
T$_{RATFM}$	Read access time (FM)		340	ns	
T$_{ODH}$	Output disable time	20	80	ns	

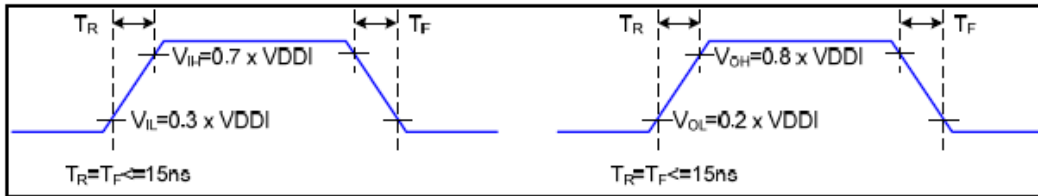**Table 4 8080 Parallel Interface Characteristics**

Figure 2 Rising and Falling Timing for I/O Signal
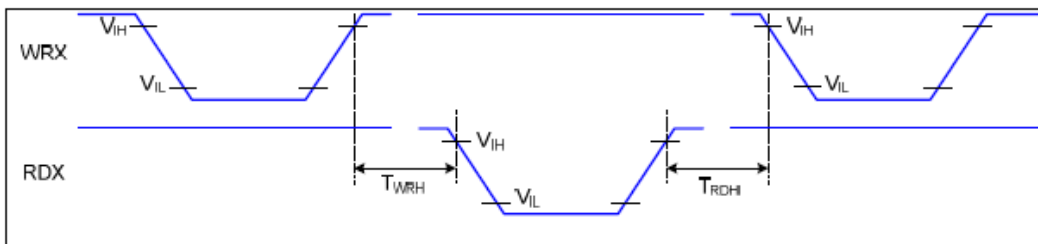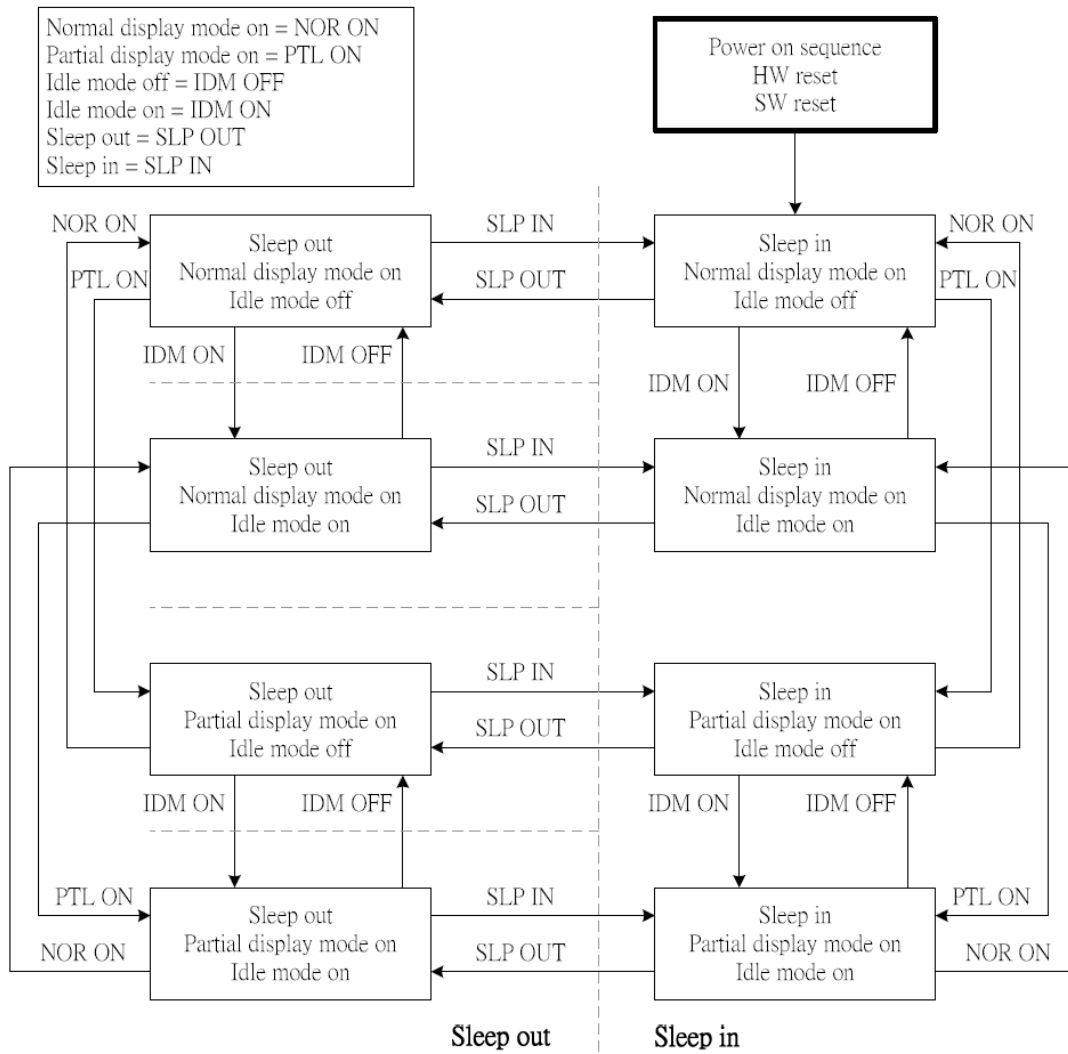

Figure 3 Write-to-Read and Read-to-Write Timing

Note: The rising time and falling time (Tr, Tf) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

9 SETUP FLOW OF POWER SUPPLY

10. RELIABILITY

Test Item	Test Conditions	Note
High Temperature Operation	70±3°C , t=240 hrs	
Low Temperature Operation	-20±3°C , t=240 hrs	
High Temperature Storage	80±3°C , t=240 hrs	1,2
Low Temperature Storage	-30±3°C , t=240 hrs	1,2
Storage Humidity Test	60°C , Humidity 90%, 240 hrs	1,2
Thermal Shock Test	-30°C ~ 25°C ~ 80°C 30 min. 5 min. 30 min. (1 cycle) Total 5 cycle	1,2
Vibration Test (Packing)	Sweep frequency：10~55~10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis	2

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions

(15-35°C , 45-65%RH).

Definitions of life end point :

- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

11. USE PRECAUTIONS

11.1 Handling precautions

1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.

2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.

3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.

4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

11.2 Installing precautions

1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. 1MΩ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.

2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.

3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.

4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

11.3 Storage precautions

1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.

2) Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.

3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

11.4 Operating precautions

1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.

2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.

3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.

4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.

5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.

6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.

7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that

they are shielded from light emissions.

8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

11.5 Other

1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.

2) The residual image may exist if the same display pattern is shown for hours. This residual image, however, disappears when another display pattern is shown or the drive is interrupted and left for a while. But this is not a problem on reliability.

3) US Micro Products will provide one year warrantee for all products.

12 Mechanical Drawing

Pin Assignment (A Block / RGB):

1	GND	21	DB13
2	GND	22	DB14
3	CSX	23	DB15
4	DCX	24	LED A
5	WRX	25	LED K
6	RDX	26	DB16
7	RESX	27	DB17
8	DB0	28	IM3
9	DB1	29	IM2
10	DB2	30	IM1
11	DB3	31	IM0
12	DB4	32	SDA
13	DB5	33	SDO
14	DB6	34	VSYNC
15	DB7	35	HSYNC
16	DB8	36	DOTCLK
17	DB9	37	NC(DOTCLK)
18	DB10	38	NC
19	DB11	39	VDD
20	DB12	40	VDDI

Note:

1. Unless indicated, Tolerance ±0.3 is adopted.
2. LCD DISPLAY TYPE: Color TFT, Transmissive, Normal Black
3. LCD DRIVER: ST7789S-G4
4. OPERATING TEMP: -20°C~70°C
5. STORAGE TEMP: -30°C~80°C
6. BACKLIGHT: 3 Chip-White _LED
7. RECOMMEND CONNECTOR: SD-54132-064

LED Circuit diagram

$If=15mA, Vf=8.7(typ.)$

Back view

AG Paste

Stiffener L=5.5±0.5
Contact L=3.5±0.3

71.9±0.7
51.62±0.3 (LCD)
47.84±0.3 (LCD)
46.24±0.2 (V,A)
44.64 (A,A)
36.48±0.3 (LCD)
35.08±0.2 (V,A)
33.48 (A,A)
4.0±0.2 (LED)
56.9±0.2 (LED)
30.338±0.3
15.0±0.5
20.05±0.3
2-R0.3
38.1±0.3
13.0±0.3
13.7±0.5
P0.5x39,W=0.35
20.5±0.1
9.8±0.5

TITLE: USMP-T022-024032NCJ-A0

PARTS NO. LCM 24032OJ4

DWN: LEO

DATE: 09-16-'3'

SHEET 1 OF 1

REV	REVISION RECORD	DATE	NAME
0	NEW RELEASE	09-16-13	LEO
1	TFT24032OJ-168-0 Rename to 24032OJ4_LCD Chang dimensions	11-20-13	LEO
2	Charge FPC shape and modify interface, FPC length 12.5 to 13.0	12-16-13	LEO
3	Modify dimensions 14.2/3.17 to 13.7/3.15	06-16-14	LEO